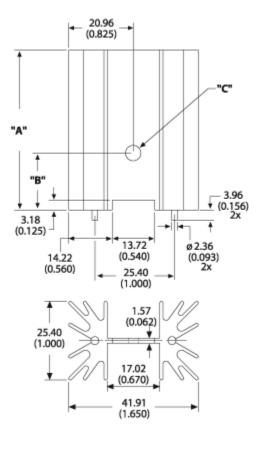


For use with TO-218 packages

Part Number - 530001B02500G				
RoHS √ Compliant	Product Change Notice			

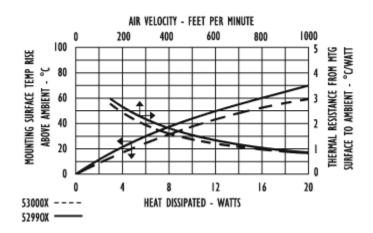


Mechanical Outline Drawing



A Dim 63.50 B Dim 21.59 C Dim 3.66

Thermal Curves



Thermal	8.00
Resistance	8.00

Thermal resistance value is based on a 75°C rise in natural convection

Product Information

Part #	Description	Finish	Board Mounting	
530001B02500G	Extruded heat sink with large radial fins and solderable pins	Black Anodize	View Hole Dimensions	
This non-electronic component is functionally unaffected by the normal soldering or reflow processes used for semiconductor circuits. The heat resistance time or heat resistance temperature is not applicable for the				

component.